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| APPLICATION NO. | F | ILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. |
|--|-----------------------|------------|-------------------------|---------------------|------------------|
| 10/091,461 | 10/091,461 03/07/2002 | | Masataka Ito | 00862.022541 | 8794 |
| 5514 | 7590 | 06/13/2002 | | | |
| | | LLA HARPER | EXAMINER | | |
| 30 ROCKEFELLER PLAZA NEW YORK, NY 10112 | | | | ISAAC, STANETTA D | |
| | | | | ART UNIT | PAPER NUMBER |
| | | | 2812 | | |
| | | | DATE MAILED: 06/13/2002 | | |

Please find below and/or attached an Office communication concerning this application or proceeding.

| | | Application No. | Applicant(s) |
|---|---|--|--|
| | | 10/091,461 | ITO, MASATAKA |
| • | Office Action Summary | Examiner | Art Unit |
| • | | Stanetta D. Isaac | 2812 |
| | The MAILING DATE of this communica | tion appears on the cover sheet wit | h the correspondence address |
| ariad for | Reply | | |
| THE M - Extens after S - If the - If NO - Failure | PRIENED STATUTORY PERIOD FOR AILING DATE OF THIS COMMUNICATIONS of time may be available under the provisions of SIX (6) MONTHS from the mailing date of this communication for reply specified above is less than thirty (30) deperiod for reply is specified above, the maximum statute to reply within the set or extended period for reply will poly received by the Office later than three months after department adjustment. See 37 CFR 1.704(b). | ATTON. TO CFR 1.136(a). In no event, however, may a recation. ays, a reply within the statutory minimum of thirty bry period will apply and will expire SIX (6) MON | eply be timely filed y (30) days will be considered timely. THS from the mailing date of this communication. ANDONED (35 U.S.C. § 133). |
| tatus | the A. Elec | l an | |
| 1) | Responsive to communication(s) filed | on)⊠ This action is non-final. | |
| 2a)☐ | This action is FINAL . 2b Since this application is in condition for |) This action is non-line. | tters prosecution as to the merits is |
| 3) | Since this application is in condition is closed in accordance with the practic | e under <i>Ex par</i> te <i>Quayle</i> ; 1935 C. | D. 11, 453 O.G. 213. |
|)ispositi | on of Claims | · | |
| 4)[🛛 | Claim(s) 1-8 and 10-17 is/are pending | g in the application. | |
| ,— | 4a) Of the above claim(s) 9 and 18 is/a | are withdrawn from consideration. | |
| | Claim(s) is/are allowed. | | |
| | Claim(s) 1-8 and 10-17 is/are rejected | l. | |
| 7)[7 | Claim(s) is/are objected to. | | |
| | Claim(s) are subject to restrict | on and/or election requirement. | |
| | ion Papers | | |
| 9)[| The specification is objected to by the | Examiner. | the Evaminer |
| 10)[| The drawing(s) filed on is/are: | a) accepted or b) objected to by | vance See 37 CFR 1.85(a). |
| | Applicant may not request that any objection filed | ection to the drawing(s) be field in abc | disapproved by the Examiner. |
| 11) | The proposed drawing correction filed | uirod in reply to this Office action. | C. C |
| _ | If approved, corrected drawings are req | by the Examiner | |
| | The oath or declaration is objected to | by the Examinon | |
| Priority | under 35 U.S.C. §§ 119 and 120 Acknowledgment is made of a claim | for foreign priority under 35 U.S.C | : § 119(a)-(d) or (f). |
| | | for foreign priority under do die. | |
| а | a) ☐ All b) ☐ Some * c) ☒ None of: | documents have been received. | |
| | 1. Certified copies of the priority | documents have been received. documents have been received in | Application No |
| | 2. Certified copies of the priority3. Copies of the certified copies | of the priority documents have be | en received in this National Stage |
| , | application from the Intern | n for a list of the certified copies n | ot received. |
| 14) | Acknowledgment is made of a claim f | or domestic priority under 35 U.S. | C. § 119(e) (to a provisional application). |
| | a) The translation of the foreign land Acknowledgment is made of a claim | nguage provisional application has | s been received. |
| Attachm | | | |
| | otice of References Cited (PTO-892) otice of Draftsperson's Patent Drawing Review (formation Disclosure Statement(s) (PTO-1449) f | PTO-948) 5) Notice | ew Summary (PTO-413) Paper No(s) of Informal Patent Application (PTO-152) |
| IIS Patent a | nd Trademark Office | ara - Astion Cummant | Part of Paper No. 2 |

Application/Control Number: 10/091,461

Art Unit: 2812

DETAILED ACTION

Election/Restrictions

An examiner's amendment to the record appears below. Should the changes and/or 1. additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with Attorney Karl Quinn on 06/07/02 with traverse, in addition, the attorney did not give any reason for traverse.

Claims 9 and 18 are cancelled.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the 1. basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in-

(1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effect under this subsection of a national application published under section 122(b) only if the international application designating the United States was published under Article 21(2)(a) of such treaty in the English language; or

(2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that a patent shall not be deemed filed in the United States for the purposes of this subsection based on the filing of an international application filed under the treaty defined in section 351(a).

Claims 1-8 and 10-17 are rejected under 35 U.S.C. 102(e) as being clearly anticipated by 2. Sato et al. Patent Number 6180497.

Sato discloses:

(Col. 2 lines 61-67; col. 3 lines 7-9, 50-62; col. 7 lines 67 continued to col. 8 lines 1; col.

8 lines 30-37, 39-43)

Page 3

Application/Control Number: 10/091,461

Art Unit: 2812

An annealing method of annealing an SOI substrate
 (Col. 2 lines 1-6, 61-67; col. 3 lines 7-9, 50-62; col. 7 lines 67 continued to col. 8 lines 1;
 col. 8 lines 30-37, 39-43)

in a reducing atmosphere, comprising the step of:

holding the SOI substrate by a holding portion

having a surface formed from silicon and annealing the

SOI substrate.

2. The method according to claim 1, wherein the annealing is executed at a temperature lower than a melting point of single-crystal silicon.

(col. 7 lines 67 continued to col. 8 line 1)

- 3. The method according to claim 1, wherein the annealing is executed at a temperature not less than 775°C.
- 4. The method according to claim 1, wherein the annealing is executed at a temperature not less than 966°C.
- 5. The method according to claim 1, wherein the annealing is executed at a temperature not less than 993°C.
- 6. An SOI substrate manufactured using an annealing

Application/Control Number: 10/091,461

Art Unit: 2812

method of any one of claims 1.

(col. 3 lines 7-9, 50-62)

7. The substrate according to claim 6, wherein an HF defect density is not more than 0.05 defects /CM2.

(col. 8 lines 30-37, 39-43)

8. A semiconductor device manufacturing method, comprising the steps of:

annealing an SOI substrate using an annealing method of any one of claims 1; and

forming an active region for a transistor in a nonporous semiconductor layer of the SOI substrate.

(Col. 2 lines 1-6, 61-67; col. 3 lines 7-9, 50-62; col. 7 lines 67 continued to col. 8 lines 1; col. 8 lines 30-37, 39-43)

10. An annealing method of annealing an SOI substrate in a reducing atmosphere, comprising the step of:

holding the SOI substrate by a holding portion which contains no silicon carbide formed by sintering and has a surface formed from silicon carbide deposited by CVD and annealing the SOI substrate.

11. The method according to claim 10, wherein the

Application/Control Number: 10/091,461

Art Unit: 2812

annealing is executed at a temperature lower than a melting point of single-crystal silicon.

- 12. The method according to claim 10, wherein the annealing is executed at a temperature not less than 775°C.
 - 13. The method according to claim 10, wherein the annealing is executed at a temperature-not less than 966°C.
 - 14. The method according to claim 10, wherein the annealing is executed at a temperature not less than 993°C.
 - 15. An SOI substrate manufactured using an annealing method of any one of claims 10.
- 16. The substrate according to claim 15, wherein an HF defect density is not more than 0.05 defects/cm 2.
- 17. A semiconductor device manufacturing method, comprising the steps of:

annealing an SOI substrate using an annealing method of any one of claims 10; and

forming an active region for a transistor in a nonporous semiconductor layer of the SOI substrate.

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(Col. 2 lines 1-6, 61-67; col. 3 lines 7-9, 50-62; col. 7 lines 67 continued to col. 8 lines 1; col. 8 lines 30-37, 39-43)

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Stanetta D. Isaac whose telephone number is 703-308-5871. The examiner can normally be reached on Monday-Friday 7:30am -5:30pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, John Nebling can be reached on 703-308-3325. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-308-3432 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

Stanetta Isaac Patent Examiner June 11, 2002

John F. Niebling
Supervisory Patent Examiner
Technology Center 2800